

LFPAK88

Driving power-density to the next level

Providing a true alternative to D2PAK, Nexperia's LFPAK88 delivers industry leading power density in a truly innovative 8mm x 8mm footprint. Delivering 2x higher continuous current rating, ultimate thermal performance and reliability, and up to 60% space efficiency, making LFPAK88 the MOSFET of choice for the most challenging new designs. Available in both automotive AEC-Q101 and industrial grades.

Space saving footprint



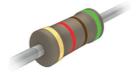
D²PAK Vs LFPAK88

- > 60% footprint reduction
- > 65% height reduction
- > 86% overall space reduction

Reliable & Manufacturable



- Advanced package design exceeds 2x AEC-Q101
- > Recommended for automotive applications such as power steering, ABS braking, DC/DC conversion and LED lighting



- **>** Latest low voltage superjunction technology
- > 0.7 mΩ @ 40 V
- Copper clip technology gives low electrical and thermal resistance
- > Low R_{DS(on)} without compromising SOA capability

High Current Rating



- > Up to 425 A continuous current rating
- > High transient robustness
- > 100% avalanche tested (310 Amps)
- **>** Best-in-class linear mode (SOA) performance for in-rush & surge protection





AEC-Q101 LFPAK88 Portfolio

| Type number | V _{DS} max (V) | R _{DS(on)} max @ 10 V (mΩ) | I _D max @ 25°C (A) | R _{th(j-mb)} typ (K/W) |
|--------------|-------------------------|--|-------------------------------|---------------------------------|
| BUK7S0R7-40H | 40 | 0.7 | 425 | 0.25 |
| BUK7S0R9-40H | 40 | 0.9 | 375 | 0.28 |
| BUK7S1R0-40H | 40 | 1.0 | 325 | 0.39 |

Industrial LFPAK88 Portfolio

| Type number | V _{DS} max (V) | R _{DS(on)} max @ 10 V (mΩ) | I _D max @ 25°C (A) | R _{th(j-mb)} typ (K/W) |
|---------------|-------------------------|--|-------------------------------|---------------------------------|
| PSMNR70-40SSH | 40 | 0.7 | 425 | 0.25 |
| PSMNR90-40SSH | 40 | 0.9 | 375 | 0.28 |
| PSMN1R0-40SSH | 40 | 1.0 | 325 | 0.32 |

Compact footprint

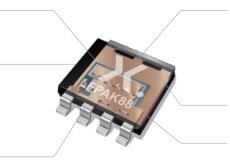
- D²PAK replacement
- > Low profile

Manufacturability & robustness

- Flexible leads for temp cycling reliability
- Compatible with SMD soldering and AOI

High performance sillicon

- > 0.7 mΩ Trench 9 40 V
- > Improved SOA



Copper clip

- Tested high I_D max rating (425 A)
- **)** Low inductance (1 nH)
- Current spreading
- > Low R_{DS(on)}

Low thermal resistance

 \rightarrow Low R_{th(i-mb)} typ (0.25 K/W)

Qualification

- **>** AEC-O101
- > 175 °C rating
- > MSL1
- Halogen free

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